

ETD 29/16/10 Core and accessories

 Series/Type:
 B66358, B66359

 Date:
 May 2017

© EPCOS AG 2017. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



### Core

- To 62317-6
- For SMPS transformers with optimum weight/performance ratio at small volume
- Delivery mode: single units

## Magnetic characteristics (per set)

 $\Sigma I/A = 0.93 \text{ mm}^{-1}$   $I_e = 70.4 \text{ mm}$   $A_e = 76.0 \text{ mm}^2$   $A_{min} = 71.0 \text{ mm}^2$   $V_e = 5350 \text{ mm}^3$ 

## Approx. weight 28 g/set

# Ungapped

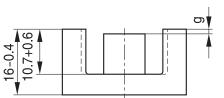
Material	A <sub>L</sub> value nH	μ <sub>e</sub>	P <sub>V</sub> W/set	Ordering code
N27	2000 +30/-20%	1470	< 1.04 (200 mT, 25 kHz, 100 °C)	B66358G0000X127
N87	2200 +30/-20%	1610	< 2.80 (200 mT, 100 kHz, 100 °C)	B66358G0000X187
N97	2250 +30/-20%	1670	< 2.40 (200 mT, 100 kHz, 100 °C)	B66358G0000X197

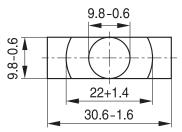
### **Gapped** (A<sub>L</sub> values/air gaps examples)

Material	g mm	A <sub>L</sub> value approx. nH	μ <sub>e</sub>	Ordering code ** = 27 (N27) = 87 (N87)
N27,	0.10 ±0.02	621	457	B66358G0100X1**
N87	0.20 ±0.02	383	281	B66358G0200X1**
	0.50 ±0.05	201	148	B66358G0500X1**
	1.00 ±0.05	124	91	B66358G1000X1**

The  $A_L$  value in the table applies to a core set comprising one ungapped core (dimension g = 0 mm) and one gapped core (dimension g > 0 mm).

Other A<sub>1</sub> values/air gaps and materials available on request – see Processing remarks on page 6.





FEK0044-8

B66358



Core

B66358

# Calculation factors (for formulas, see "E cores: general information")

Material	Relationship air gap – A <sub>L</sub> v		Calculation o	f saturation cu	irrent	
	K1 (25 °C)	K2 (25 °C)	K3 (25 °C)	K4 (25 °C)	K3 (100 °C)	K4 (100 °C)
N27	124	-0.7	195	-0.847	181	-0.865
N87	124	-0.7	192	-0.796	176	-0.873

Validity range:

K1, K2: 0.10 mm < s < 2.00 mm K3, K4: 70 nH <  $A_L$  < 680 nH



### Accessories

B66359

## **Coil former** (magnetic axis horizontal)

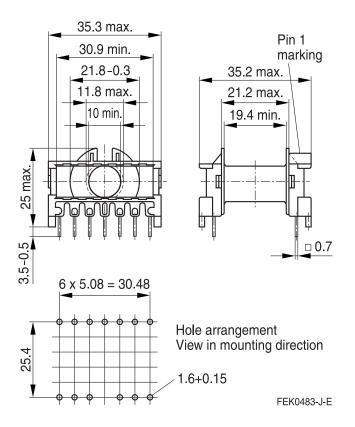
Material:	GFR polyterephthalate, UL 94 V-0, insulation class to IEC 60085:
	B66359B: F ≙ max. operating temperature 155 °C, color code black
	Valox 420-SE0 [E207780 (M)] SABIC JAPAN L L C
	B66359W: H ≙ max. operating temperature 180 °C, color code black
	Rynite FR 530 <sup>®</sup> [E41938 (M)], E I DUPONT DE NEMOURS & CO INC
Solderability:	to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s
Resistance to	soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s
Winding:	see Processing notes, 2.1
Pins:	Squared pins

#### Yoke

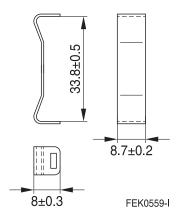
Material: Stainless spring steel (0.3 mm)

Coil former		Ordering code			
Sections	A <sub>N</sub> mm <sup>2</sup>	l <sub>N</sub> mm	A <sub>R</sub> value μΩ	Pins	
1	97	52.8	18.7	13	B66359B1013T001 B66359W1013T001
Yoke (orde	ring code pe	er piece, 2 are r	equired)		B66359S2000X000

# **Coil former**



Yoke



Please read *Cautions and warnings* and *Important notes* at the end of this document.

4



### Accessories

# **Coil former** (magnetic axis vertical)

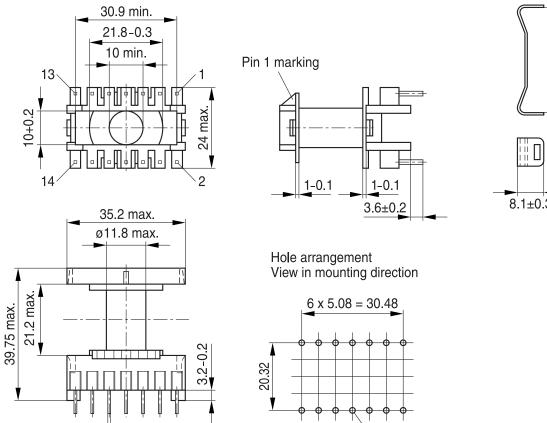
Material:	GFR polyterephthalate (UL 94 V-0, insulation class to IEC 60085: H ≙ max. operating temperature 180 °C), color code black Rynite FR 530® [E41938 (M)], E I DUPONT DE NEMOURS & CO INC
	to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s soldering heat: to IEC 60068-2-20, test Tb, method 1B: 350 °C, 3.5 s see Processing notes, 2.1 Squared pins

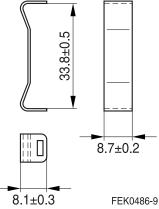
# Yoke

Material: Stainless spring steel (0.3 mm)

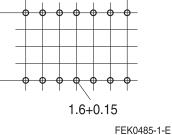
Coil former		Ordering code			
Sections	A <sub>N</sub> mm <sup>2</sup>	l <sub>N</sub> mm	A <sub>R</sub> value μΩ	Pins	
1	97	52.8	18.7	14	B66359X1014T001
Yoke (orde	ring code pe	er piece, 2 are r	required)		B66359S2000X000

### **Coil former**





Yoke



Please read Cautions and warnings and Important notes at the end of this document.

□ 0.7

B66359



#### Cautions and warnings

### Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

### Effects of core combination on A<sub>L</sub> value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

### Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

#### **NiZn-materials**

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

### **Ferrite Accessories**

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

### **Processing remarks**

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter *"Processing notes"*, section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.



#### **Cautions and warnings**

## **Display of ordering codes for EPCOS products**

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

7



# Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm <sup>2</sup>
A <sub>e</sub>	Effective magnetic cross section	mm <sup>2</sup>
AL	Inductance factor; $A_L = L/N^2$	nH
A <sub>L1</sub>	Minimum inductance at defined high saturation ( $\triangleq \mu_a$ )	nH
A <sub>min</sub>	Minimum core cross section	mm <sup>2</sup>
A <sub>N</sub>	Winding cross section	mm <sup>2</sup>
A <sub>R</sub>	Resistance factor; $A_R = R_{Cu}/N^2$	μΩ = 10 <sup>-6</sup> Ω
В	RMS value of magnetic flux density	Vs/m², mT
ΔB	Flux density deviation	Vs/m², mT
Ê	Peak value of magnetic flux density	Vs/m², mT
ΔÂ	Peak value of flux density deviation	Vs/m², mT
B <sub>DC</sub>	DC magnetic flux density	Vs/m², mT
B <sub>R</sub>	Remanent flux density	Vs/m², mT
B <sub>S</sub>	Saturation magnetization	Vs/m², mT
C <sub>0</sub>	Winding capacitance	F = As/V
CDF	Core distortion factor	mm <sup>-4.5</sup>
DF	Relative disaccommodation coefficient DF = $d/\mu_i$	
d	Disaccommodation coefficient	
E <sub>a</sub>	Activation energy	J
f	Frequency	s <sup>-1</sup> , Hz
f <sub>cutoff</sub>	Cut-off frequency	s <sup>–1</sup> , Hz
f <sub>max</sub>	Upper frequency limit	s <sup>-1</sup> , Hz
f <sub>min</sub>	Lower frequency limit	s <sup>–1</sup> , Hz
f <sub>r</sub>	Resonance frequency	s <sup>-1</sup> , Hz
f <sub>Cu</sub>	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H <sub>DC</sub>	DC field strength	A/m
H <sub>c</sub>	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 <sup>–6</sup> cm/A
h/μ <sub>i</sub> ²	Relative hysteresis coefficient	10 <sup>–6</sup> cm/A
1	RMS value of current	A
I <sub>DC</sub>	Direct current	A
î	Peak value of current	A
J	Polarization	Vs/m <sup>2</sup>
k	Boltzmann constant	J/K
k <sub>3</sub>	Third harmonic distortion	
k <sub>3c</sub>	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



# Symbols and terms

Symbol	Meaning	Unit
ΔL/L	Relative inductance change	Н
L <sub>0</sub>	Inductance of coil without core	Н
L <sub>H</sub>	Main inductance	Н
L <sub>p</sub>	Parallel inductance	Н
L <sub>rev</sub>	Reversible inductance	Н
Ls	Series inductance	Н
l <sub>e</sub>	Effective magnetic path length	mm
I <sub>N</sub>	Average length of turn	mm
Ν	Number of turns	
P <sub>Cu</sub>	Copper (winding) losses	W
P <sub>trans</sub>	Transferrable power	W
P <sub>V</sub>	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan $\delta_L$ )	
R	Resistance	Ω
R <sub>Cu</sub>	Copper (winding) resistance (f = 0)	Ω
R <sub>h</sub>	Hysteresis loss resistance of a core	Ω
$\Delta R_h$	R <sub>h</sub> change	Ω
R <sub>i</sub>	Internal resistance	Ω
R <sub>p</sub>	Parallel loss resistance of a core	Ω
R <sub>s</sub>	Series loss resistance of a core	Ω
R <sub>th</sub>	Thermal resistance	K/W
R <sub>V</sub>	Effective loss resistance of a core	Ω
S	Total air gap	mm
Т	Temperature	°C
$\Delta T$	Temperature difference	K
Т <sub>С</sub>	Curie temperature	°C
t	Time	S
t <sub>v</sub>	Pulse duty factor	
tan δ	Loss factor	
tan $\delta_L$	Loss factor of coil	
tan δ <sub>r</sub>	(Residual) loss factor at $H \rightarrow 0$	
tan $\delta_e$	Relative loss factor	
tan δ <sub>h</sub>	Hysteresis loss factor	
tan δ/μ <sub>i</sub>	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V <sub>e</sub>	Effective magnetic volume	mm <sup>3</sup>
Z	Complex impedance	Ω
Z <sub>n</sub>	Normalized impedance $ Z _n =  Z  / N^2 \times \varepsilon (I_e / A_e)$	Ω/mm



# Symbols and terms

Symbol	Meaning	Unit		
α	Temperature coefficient (TK)			
$\alpha_{F}$	Relative temperature coefficient of material	1/K		
α <sub>e</sub>	Temperature coefficient of effective permeability	1/K		
ε <sub>r</sub>	Relative permittivity			
Φ	Magnetic flux	Vs		
η	Efficiency of a transformer			
η <sub>B</sub>	Hysteresis material constant	mT <sup>-1</sup>		
η <sub>i</sub>	Hysteresis core constant	A-1H-1/2		
λ <sub>s</sub>	Magnetostriction at saturation magnetization			
μ	Relative complex permeability			
μ <sub>0</sub>	Magnetic field constant	Vs/Am		
μ <sub>a</sub>	Relative amplitude permeability			
μ <sub>app</sub>	Relative apparent permeability			
μ <sub>e</sub>	Relative effective permeability			
μ <sub>i</sub>	Relative initial permeability			
μ <sub>p</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)			
μ <sub>p</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)			
μ <sub>r</sub>	Relative permeability			
μ <sub>rev</sub>	Relative reversible permeability			
μ <sub>s</sub> '	Relative real (inductive) component of $\overline{\mu}$ (for series components)			
μ <sub>s</sub> "	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)			
μ <sub>tot</sub>	Relative total permeability			
	derived from the static magnetization curve			
р	Resistivity	$\Omega m^{-1}$		
ΣΙ/Α	Magnetic form factor	mm <sup>-1</sup>		
τ <sub>Cu</sub>	DC time constant $\tau_{Cu}$ = L/R <sub>Cu</sub> = A <sub>L</sub> /A <sub>R</sub>	S		
ω	Angular frequency; $\omega$ = 2 $\Pi$ f	s <sup>-1</sup>		

All dimensions are given in mm.

Surface-mount device

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.

We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

- 6. Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.
- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

Release 2018-10

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# EPCOS / TDK:

 B66359A2000X
 B66359B1013T001
 B66359X1014T001
 B66358G1000X127
 B66358G1000X187

 B66358G0000X127
 B66358G0000X187
 B66358G0100X127
 B66358G0100X187
 B66358G0200X187

 B66358G0200X187
 B66358G0500X127
 B66358G0500X127
 B66358G0000X187
 B66358G0000X197
 B66359S2000X000



Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;

- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);

- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;

- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком):

- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный) Факс: 8 (812) 320-03-32 Электронная почта: ocean@oceanchips.ru Web: http://oceanchips.ru/ Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А